



# Product Change Notification

**Change Notification #:** 117578 - 01  
**Change Title:** Intel® NUC Pro Assembly Element CMA1BB  
Intel® NUC Pro Board Element CMB1BB,  
PCN 117578-01, Label,  
Add new rating label for BSMI  
**Reason for Revision: Updating post change label image**  
**Date of Publication:** May 13, 2020

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:


<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	June 1, 2020
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## Description of Change to the Customer:

### Reason for Revision: Updating post change label image

The Intel® NUC SKUs listed in the Product Affected Table below will have the following changes.

1. Rating label update. (Add Taiwan BSMI.)

Before	 <p>The image shows a rectangular label for Intel NUC Pro Board Element. On the left is the Intel logo. To its right, the text reads: 'Intel® NUC Pro Board Element', 'Intel® NUC Pro 電腦元件主板', and 'Intel® NUC Pro 电脑元件主板'. Below this is 'INTEL CORPORATION', '2200 Mission College Blvd.', and 'Santa Clara, CA 95054 USA'. Further down, it lists 'Product code:', '型號/型号/Regulatory Model: CM1BB', '製造日期/制造日期/', 'Date of Manufacture:', '中國製造/中国制造/Made In China', and 'CAN ICES-3(B)/NMB-3(B)'. On the right side of the label, there are regulatory symbols: FCC, CE, a crossed-out trash can, and a '10' in a circle. Below these symbols is the text 'R-R-CPU-CM1BB'.</p>
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After

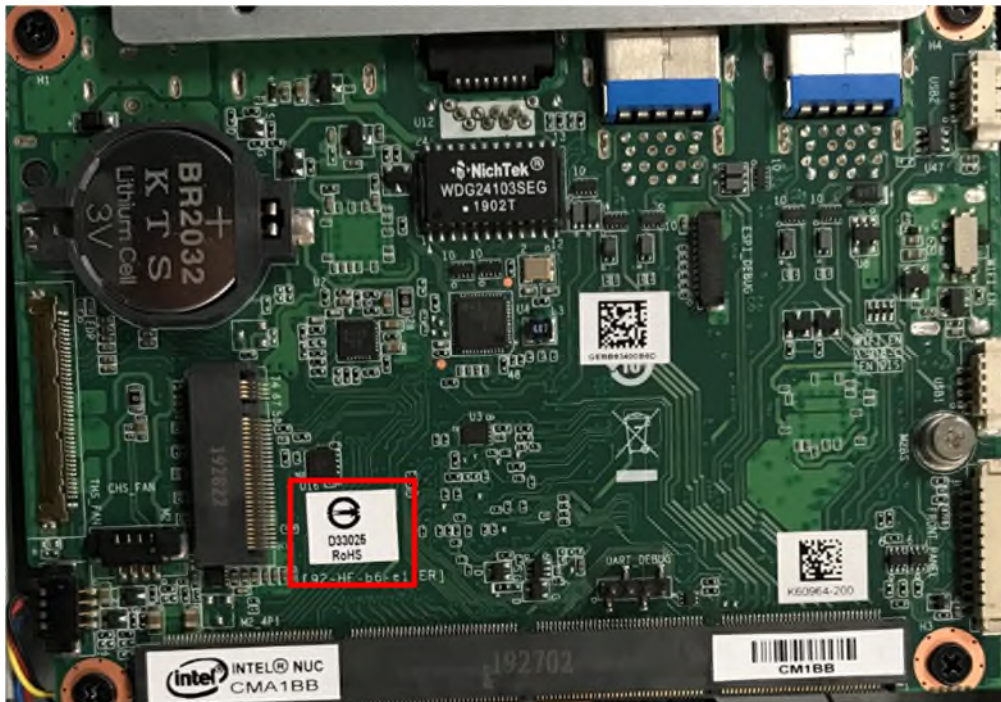
**intel** Intel® NUC Pro Board Element  
Intel® NUC Pro 電腦元件主板  
Intel® NUC Pro 电脑元件主板  
INTEL CORPORATION  
2200 Mission College Blvd,  
Santa Clara, CA 95054 USA

Product code:  
型號/型号/Regulatory Model: CM1BB  
製造日期/制造日期/  
Date of Manufacture:  
中國製造/中国制造/Made In China  
CAN ICES-3(B)/NMB-3(B)

R-R-CPU-CM1BB

FC CE 10  
D33025 RoHS  
廢電池請回收

2. Add BSMI logo on PCBA.



## Customer Impact of Change and Recommended Action:

The change to the label does not affect the functionality of the product.

Customer should be aware of these changes and take any actions so as to not impact their receiving and integration of product with the new label.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BKCMB1BB	999M8T	NA	K60964-202	NA	K60964-203
BKCMA1BB	999M9F	K73388-202	K60964-202	K73388-203	K60964-203

## PCN Revision History:

**Date of Revision:**

May 4, 2020

[May 13, 2020](#)

**Revision Number:**

00

[01](#)

**Reason:**

Originally Published PCN

[Updating post change label image](#)



# Product Change Notification

## 117578 - 01

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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